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ISL9K1560G3 — STEALTH™ Dual Diode

November 2013

FAIRCHILD

SEMICONDUCTOR®

ISL9K1560G3 30 A, 600 V STEALTH™ Dual Diode

Features

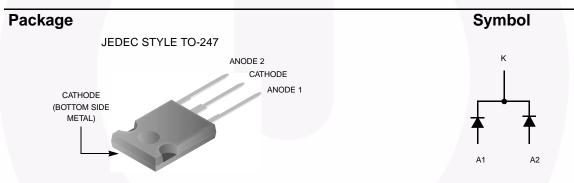
- Stealth Recovery t_{rr} = 29.4 ns (@ I_F = 15 A)
- Max Forward Voltage, $V_F = 2.2 \text{ V}$ (@ $T_C = 25^{\circ}\text{C}$)
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

Applications

- Switch Mode Power Supplies
- Hard Switched PFC Boost Diode
- UPS Free Wheeling Diode
- Motor Drive FWD
- SMPS FWD
- Snubber Diode

Description

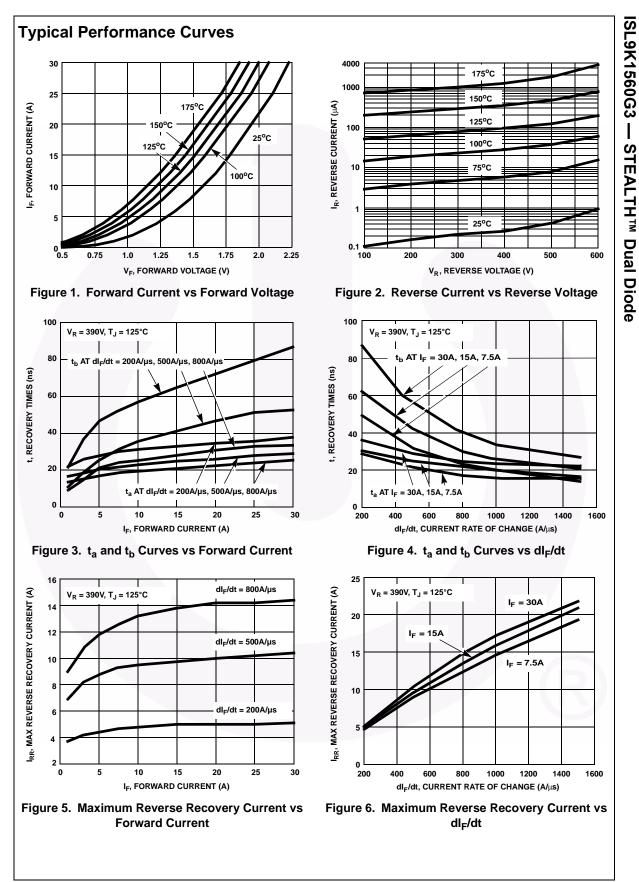
The ISL9K1560G3 is a STEALTH[™] dual diode optimized for low loss performance in high frequency hard switched applications. The STEALTH[™] family exhibits low reverse recovery current (I_{RR}) and exceptionally soft recovery under typical operating conditions. This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I_{RR} and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the STEALTH[™] diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.



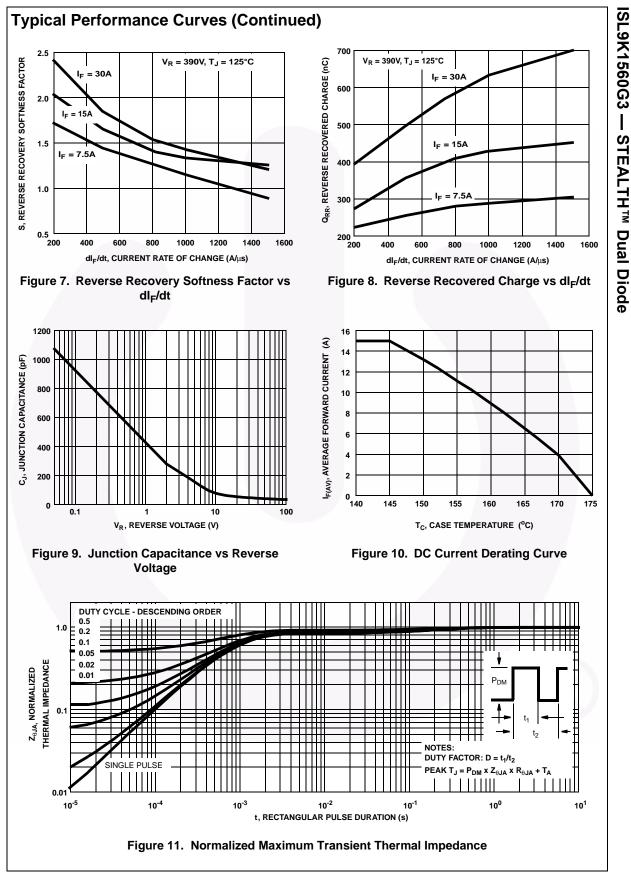
Device Maximum Ratings (per leg) T_c = 25°C unless otherwise noted

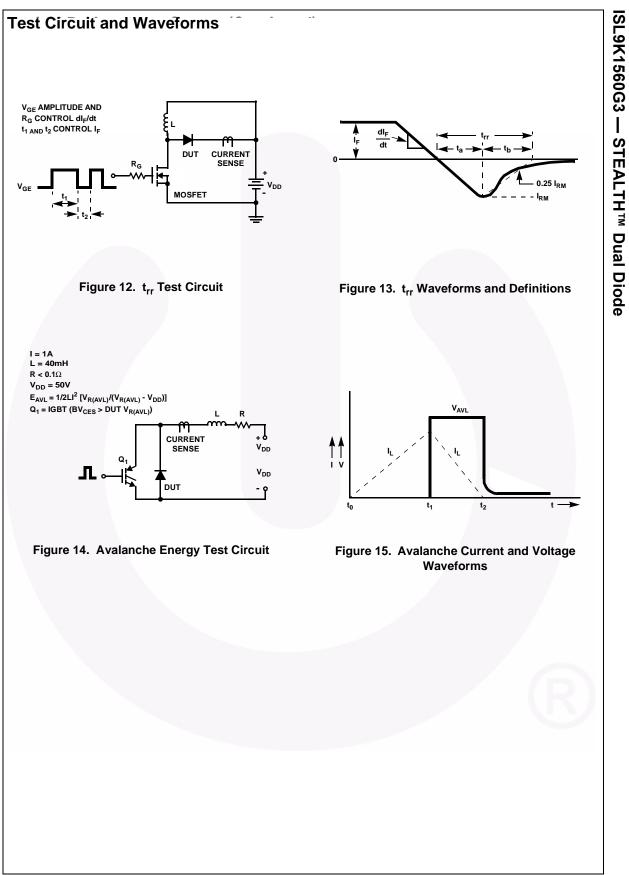
Symbol	Parameter	Rating	Unit
V _{RRM}	Repetitive Peak Reverse Voltage	600	V
V _{RWM}	Working Peak Reverse Voltage	600	V
V _R	DC Blocking Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current (T _C = 145°C)	15	A
()	Total Device Current (Both Legs)	30	A
I _{FRM}	Repetitive Peak Surge Current (20kHz Square Wave)	30	А
I _{FSM}	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60Hz)	200	Α
PD	Power Dissipation	150	W
E _{AVL}	Avalanche Energy (1A, 40mH)	20	m
Г _Ј , Т _{STG}	Operating and Storage Temperature Range	-55 to 175	°C
ΤL	Maximum Temperature for Soldering	300	°C
T _{PKG} Leads at 0.063in (1.6mm) from Case for 10s Package Body for 10s, See Techbrief TB334		260	°C

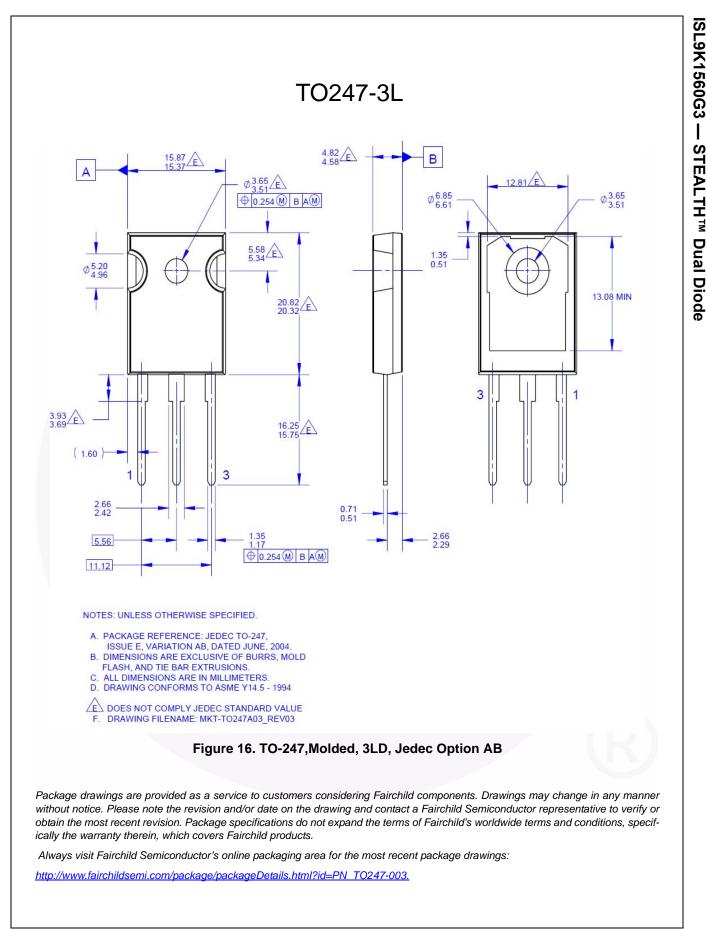
Device MarkingDeviceK1560G3ISL9K1560G3		Device	Package	Packing Methode	Tape W	/idth	Quar	ntity
		TO-247-3L	Tube	N/A		30		
lectric	al Cha	acteristics (per leg)	T _C = 25°C uni	ess otherwise noted				
Symbol Parameter		Test Conditions		Min	Тур	Max	Unit	
off State	Charact	eristics						
I _R	Instantaneous Reverse Current		V _R = 600 V	$T_{\rm C} = 25^{\circ}{\rm C}$	-	-	100	μA
				T _C = 125°C	-	-	1.0	mA
)n State	Charact	eristics						
V _F	Instantaneous Forward Voltage	ous Forward Voltage	I _F = 15 A	T _C = 25°C	-	1.8	2.2	V
		ů.		T _C = 125°C	-	1.65	2.0	V
ynamic	Charact	eristics						
C,I	Junction C	apacitance	V _R = 10 V, I _F	= 0 A	-	62	-	pF
witchin	g Charac	teristics						
t _{rr}	t _{rr} Reverse Recovery Time		-	= 100 A/ μ s, V _R = 30 V		25	30	ns
P				$dt = 100 \text{ A/}\mu\text{s}, \text{ V}_{\text{R}} = 30$	V -	35	40	ns
t _{rr}		ecovery Time	$I_{\rm F} = 15 {\rm A},$		-	29.4	-	ns
I _{rr}	Reverse Recovery Current		dl _F /dt = 200 A/μs, V _R = 390 V, T _C = 25°C		-	3.5	-	A
Q _{rr}		ecovered Charge	$V_R = 390 V, T_C = 23 C$ $I_F = 15 A,$ $dI_F/dt = 200 A/\mu s,$ $V_R = 390 V,$ $T_C = 125^{\circ}C$		-	57	-	nC
t _{rr}		ecovery Time			-	90	-	ns
S		factor (t _b /t _a)			-	2.0	-	
۱ _m		ecovery Current			-	5.0	-	A
Q _{rr}		ecovered Charge	Ű		-	275	-	nC
t _{rr}		ecovery Time	1/ - 200 1/		-	52	-	ns
S		factor (t _b /t _a)			1.36	-		
I _{rr}		ecovery Current			-	13.5	-	A
Q _{rr}	Reverse R	ecovered Charge			-	390	-	nC
dl _M /dt	Maximum	di/dt during t _b			-	800	-	A/µs
hermal	Characte	eristics						
$R_{\theta JC}$	Thermal R	esistance Junction to Case			-	-	1.0	°C/V
R_{\thetaJA}	Thermal R	esistance Junction to Ambier	nt TO-247		-	-	30	°C/V



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ISL9K1560G3 — STEALTH™ Dual Diode

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